



### **DUAL N-CHANNEL ENHANCEMENT MODE MOSFET**

### **Product Summary**

| BV <sub>DSS</sub> | Rds(ON) Max                   | I <sub>D</sub> Max<br>T <sub>A</sub> = +25°C |
|-------------------|-------------------------------|--|
| 60V               | $2\Omega$ @ $V_{GS} = 4.5V$   | 350mA  |
| 00 V              | 2.5Ω @ V <sub>GS</sub> = 2.5V | SSUTIA                                       |

## **Description and Applications**

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- Motor Control
- Power Management Functions

### **Features**

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMN62D0UDWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

### Mechanical Data

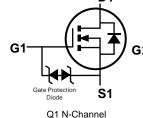
- Case: SOT363
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208<sup>(2)</sup>
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)

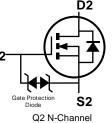


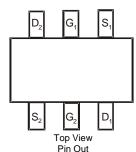


Top View

**SOT363** 







Equivalent Circuit

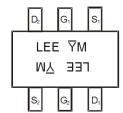
### **Ordering Information** (Note 4)

| Part Number    | Case   | Packaging         |
|----------------|--------|-------------------|
| DMN62D0UDWQ-7  | SOT363 | 3000/Tape & Reel  |
| DMN62D0UDWQ-13 | SOT363 | 10000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



LEE = Product Type Marking Code  $\overline{Y}M$  = Date Code Marking

 $\overline{Y}$  = Year (ex: H = 2020)

M = Month (ex: 9 = September)

Date Code Key

| Date Code | - ,  |      |      |      |      |      |      |      |      |      |      |      |
|-----------|------|------|------|------|------|------|------|------|------|------|------|------|
| Year      | 2019 | 2020 | 2021 | 2022 | 2023 | 2024 | 2025 | 2026 | 2027 | 2028 | 2029 | 2030 |
| Code      | G    | Н    |      | J    | K    | Ш    | М    | N    | 0    | Р    | R    | S    |
|           |      |      |      |      |      |      |      |      |      |      |      |      |
|           |      |      |      |      |      |      |      |      |      |      |      |      |
| Month     | Jan  | Feb  | Mar  | Apr  | May  | Jun  | Jul  | Aug  | Sep  | Oct  | Nov  | Dec  |

DMN62D0UDWQ
Document number: DS42017 Rev. 2 - 2



# **Maximum Ratings** (@ $T_A = +25^{\circ}C$ , unless otherwise specified.)

| Characteristic   |                 | Symbol           | Value      | Unit |   |
|--|-----------------|------------------|------------|------|---|
| Drain-Source Voltage                                     |                 | VDSS             | 60         | V    |   |
| Gate-Source Voltage                                      |                 | V <sub>GSS</sub> | ±20        | V    |   |
| Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V | Steady<br>State | lo               | 350<br>290 | mA   |   |
| Maximum Continuous Body Diode Forward Currer             | t (Note 6)      |                  | Is         | 0.4  | A |

## Thermal Characteristics ( $@T_A = +25^{\circ}C$ , unless otherwise specified.)

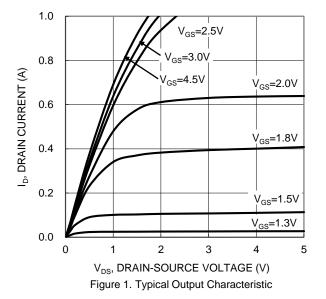
| Characteristic                                   |              | Symbol         | Value       | Unit |
|--|--------------|----------------|-------------|------|
| Total Power Dissipation (Note 5)                 |              | P <sub>D</sub> | 320         | mW   |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State | Reja           | 400         | °C/W |
| Total Power Dissipation (Note 6)                 |              | PD             | 410         | mW   |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State | Reja           | 312         | °C/W |
| Operating and Storage Temperature Range          |              | TJ, TSTG       | -55 to +150 | °C   |

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                    | Symbol               | Min | Тур  | Max | Unit | Test Condition  |
|-----------------------------------|----------------------|-----|------|-----|------|---|
| OFF CHARACTERISTICS (Note 7)      |                      |     |      | •   |      |   |
| Drain-Source Breakdown Voltage    | BV <sub>DSS</sub>    | 60  | _    |     | V    | $V_{GS} = 0V, I_{D} = 250\mu A$                           |
| Zero Gate Voltage Drain Current   | I <sub>DSS</sub>     | _   | _    | 1.0 | μΑ   | V <sub>DS</sub> = 60V, V <sub>GS</sub> = 0V               |
| Gate-Source Leakage               | lgss                 | _   | _    | ±10 | μΑ   | $V_{GS} = \pm 20V$ , $V_{DS} = 0V$                        |
| ON CHARACTERISTICS (Note 7)       |                      |     |      |     |      |   |
| Gate Threshold Voltage            | V <sub>GS</sub> (TH) | 0.5 | _    | 1.1 | V    | $V_{DS} = 10V, I_{D} = 250\mu A$                          |
|                                   |                      |     | 1.2  | 2.0 |      | $V_{GS} = 4.5V, I_{D} = 0.1A$                             |
| Static Drain-Source On-Resistance | R <sub>DS(ON)</sub>  | _   | 1.4  | 2.5 | Ω    | $V_{GS} = 2.5V, I_D = 0.05A$                              |
|                                   |                      |     | 1.8  | 3.5 |      | $V_{GS} = 1.8V, I_{D} = 0.05A$                            |
| Diode Forward Voltage             | VsD                  | _   | 0.8  | 1.3 | V    | V <sub>GS</sub> = 0V, I <sub>S</sub> = 115mA              |
| DYNAMIC CHARACTERISTICS (Note 8)  | ·                    |     |      |     |      |   |
| Input Capacitance                 | Ciss                 | _   | 32   | _   | pF   | V 00V V 0V  |
| Output Capacitance                | Coss                 | _   | 3.9  | _   | pF   | V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0V<br>f = 1.0MHz |
| Reverse Transfer Capacitance      | Crss                 | _   | 2.4  | _   | pF   | 1 = 1:01/11/12  |
| Gate Resistance                   | Rg                   | _   | 101  | _   | Ω    | $f = 1MHz$ , $V_{GS} = 0V$ , $V_{DS} = 0V$                |
| Total Gate Charge                 | Qg                   | _   | 0.5  | _   | nC   | 151/1/ 101/   |
| Gate-Source Charge                | Qgs                  | _   | 0.09 | _   | nC   | $V_{GS} = 4.5V, V_{DS} = 10V,$                            |
| Gate-Drain Charge                 | Qgd                  | _   | 0.09 | _   | nC   | $I_D = 250 \text{mA}$                                     |
| Turn-On Delay Time                | t <sub>D</sub> (ON)  | _   | 2.4  | _   | ns   |   |
| Turn-On Rise Time                 | t <sub>R</sub>       | _   | 2.5  | _   | ns   | V <sub>DD</sub> = 30V, V <sub>GS</sub> = 10V,             |
| Turn-Off Delay Time               | tD(OFF)              | _   | 22.6 | _   | ns   | $R_g = 25\Omega$ , $I_D = 200mA$                          |
| Turn-Off Fall Time                | tF                   | _   | 12.5 | _   | ns   |   |

- Device mounted on FR-4 PCB, with minimum recommended pad layout.
   Device mounted on 1" x 1" FR-4 PCB with high coverage 2oz. copper, single sided.
   Short duration pulse test used to minimize self-heating effect.
   Guaranteed by design. Not subject to product testing.





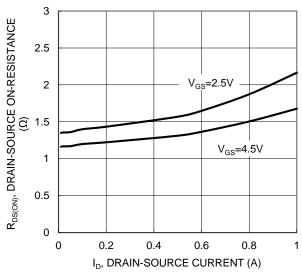


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

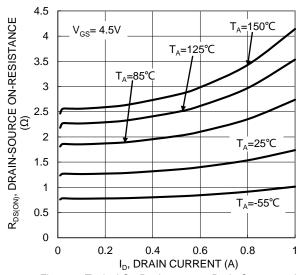


Figure 5. Typical On-Resistance vs. Drain Current and Temperature

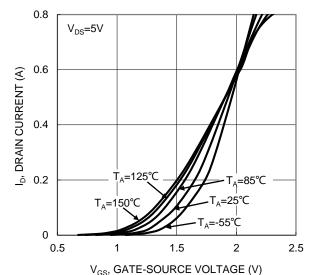


Figure 2. Typical Transfer Characteristic

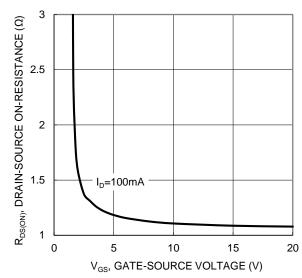


Figure 4. Typical Transfer Characteristic

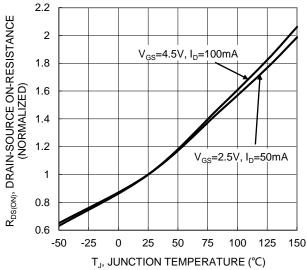


Figure 6. On-Resistance Variation with Junction Temperature



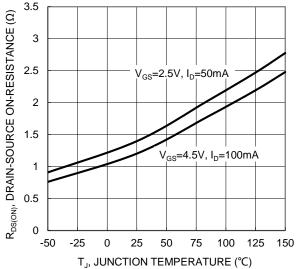


Figure 7. On-Resistance Variation with Junction Temperature

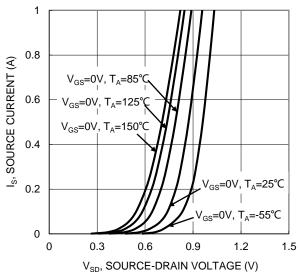


Figure 9. Diode Forward Voltage vs. Current

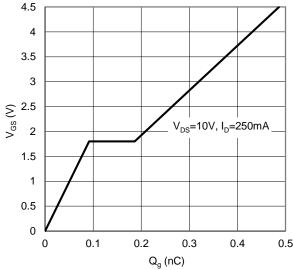


Figure 11. Gate Charge

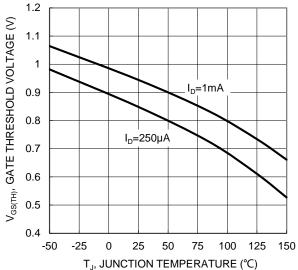
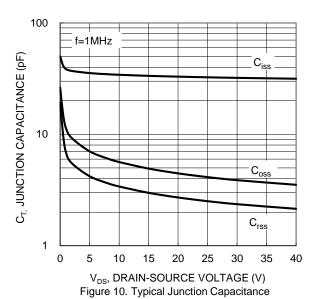


Figure 8. Gate Threshold Variation vs. Junction Temperature



10 R<sub>DS(ON)</sub> Limited DRAIN CURRENT (A) 0.1 P<sub>w</sub>=100ms T<sub>J(MAX)</sub>=150℃ ے\_ 0.01 T<sub>C</sub>=25°C Single Pulse DUT on 1\*MRP board V<sub>GS</sub>=4.5V 0.001 0.1 10 100 1 V<sub>DS</sub>, DRAIN-SOURCE VOLTAGE (V)



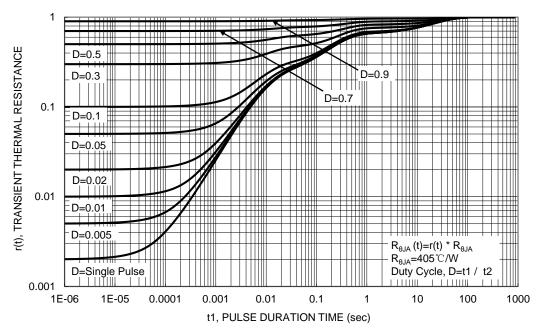


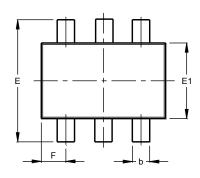
Figure 13. Transient Thermal Resistance

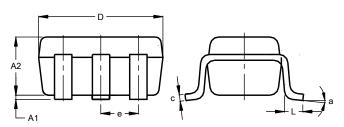


# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### **SOT363**



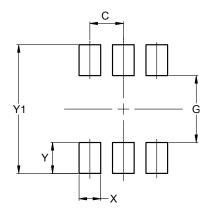


| SOT363               |           |      |       |  |  |  |  |
|----------------------|-----------|------|-------|--|--|--|--|
| Dim                  | Min       | Max  | Тур   |  |  |  |  |
| A1                   | 0.00      | 0.10 | 0.05  |  |  |  |  |
| A2                   | 0.90      | 1.00 | 0.95  |  |  |  |  |
| b                    | 0.10      | 0.30 | 0.25  |  |  |  |  |
| С                    | 0.10      | 0.22 | 0.11  |  |  |  |  |
| D                    | 1.80      | 2.20 | 2.15  |  |  |  |  |
| E                    | 2.00      | 2.20 | 2.10  |  |  |  |  |
| E1                   | 1.15      | 1.35 | 1.30  |  |  |  |  |
| е                    | 0.650 BSC |      |       |  |  |  |  |
| F                    | 0.40      | 0.45 | 0.425 |  |  |  |  |
| L                    | 0.25      | 0.40 | 0.30  |  |  |  |  |
| а                    | 0°        | 8°   |       |  |  |  |  |
| All Dimensions in mm |           |      |       |  |  |  |  |

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT363



| Dimensions | Value<br>(in mm) |  |  |  |
|------------|------------------|--|--|--|
| C          | 0.650            |  |  |  |
| G          | 1.300            |  |  |  |
| Х          | 0.420            |  |  |  |
| Υ          | 0.600            |  |  |  |
| Y1         | 2 500            |  |  |  |



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